

I12H013

Part Number

weproTec



- Increased switching distance
- Innovative ASIC circuit technology
- Integrated error display
- Minimal mounting clearance thanks to wenglor weproTec

Technical Data

Inductive Data

Switching Distance	12 mm
Correction Factors Stainless Steel V2A/CuZn/Al	1,03/0,54/0,53
Mounting	non-flush
Mounting A/B/C/D in mm	20/40/36/14
Mounting B1 in mm	0...14
Switching Hysteresis	< 10 %

Electrical Data

Supply Voltage	10...30 V DC
Current Consumption (U _b = 24 V)	< 12 mA
Switching Frequency	360 Hz
Temperature Drift	< 10 %
Temperature Range	-40...80 °C
Switching Output Voltage Drop	< 1 V
Switching Output/Switching Current	150 mA
Residual Current Switching Output	< 100 µA
Short Circuit Protection	yes
Reverse Polarity and Overload Protection	yes
Protection Class	III

Mechanical Data

Housing Material	CuZn, nickel-plated
Degree of Protection	IP67
Connection	Cable, 3-wire, 2 m
Cable Jacket Material	PVC

Safety-relevant Data

MTTFd (EN ISO 13849-1)	3706,54 a
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Function

Error Indicator	yes
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PNP NO

Connection Diagram No.

202

Suitable Mounting Technology No.

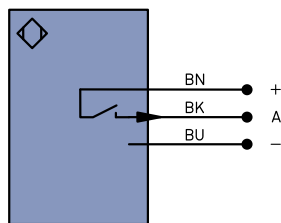
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* Temperature range with permanently installed cable, bending radius: > 40 mm

Inductive Sensors with increased switching distances are distinguished by rugged design, easy installation and reliable measured values. The large range makes additional types of sensor superfluous because they can also be used to implement special applications. In addition to error-free operation of several sensors in a very small space, the new generation also provides the possibility of detecting system errors before it's too late thanks to ASIC und wenglor weproTec.



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+	Supply Voltage +
-	Supply Voltage 0 V
~	Supply Voltage (AC Voltage)
A	Switching Output (NO)
$\bar{A}$	Switching Output (NC)
V	Contamination/Error Output (NO)
$\bar{V}$	Contamination/Error Output (NC)
E	Input (analog or digital)
T	Teach Input
Z	Time Delay (activation)
S	Shielding
RxD	Interface Receive Path
TxD	Interface Send Path
RDY	Ready
GND	Ground
CL	Clock
E/A	Output/Input programmable
	IO-Link
PoE	Power over Ethernet
IN	Safety Input
QSSD	Safety Output
Signal	Signal Output
BL-D/-	Ethernet Gigabit bidirect. data line (A-D)
EN0	Encoder 0-pulse 0-0 (TTL)

PT	Platinum measuring resistor
nc	not connected
U	Test Input
$\bar{U}$	Test Input inverted
W	Trigger Input
W –	Ground for the Trigger Input
O	Analog Output
O –	Ground for the Analog Output
BZ	Block Discharge
AWV	Valve Output
a	Valve Control Output +
b	Valve Control Output 0 V
SY	Synchronization
SY –	Ground for the Synchronization
E+	Receiver-Line
S+	Emitter-Line
$\pm$	Grounding
S_NR	Switching Distance Reduction
Rx+/-	Ethernet Receive Path
Tx+/-	Ethernet Send Path
Bus	Interfaces-Bus A(+)/B(-)
La	Emitted Light disengageable
Mag	Magnet activation
RES	Input confirmation
EDM	Contactator Monitoring

ENAR542Z	Encoder A/ $\bar{A}$ (TTL)
ENBR542Z	Encoder B/B (TTL)
ENA	Encoder A
ENB	Encoder B
AMIN	Digital output MIN
AMAX	Digital output MAX
AOK	Digital output OK
SY In	Synchronization In
SY OUT	Synchronization OUT
OLT	Brightness output
M	Maintenance
RSV	reserved
Wire Colors according to IEC 60757	
BK	Black
BN	Brown
RD	Red
OG	Orange
YE	Yellow
GN	Green
BU	Blue
VT	Violet
GY	Grey
WH	White
PK	Pink
GNYE	Green/Yellow

The figure consists of a main schematic and two insets. The main schematic shows a cross-section of a substrate with two solder bumps. Dimensions A, B, C, and D are indicated. Two inset diagrams show the solder bump being placed into a cavity, with dimensions 1,5 x Sn and B1 indicated.